



Per OSHPark specs,
min trace 5mil,
min space 5mil's,
min ringlet 4 mil's,
4 layer board stackup is as follows:
T-0 is top min 1 oz copper (1.4 mil)
min 6.7 mil prepreg FR4
T-1 is GND min 0.5 oz copper (0.7 mil)
min 47 mil core FR4
T-2 is PWR min 0.5 oz copper (0.7 mil)
min 6.7 mil prepreg FR4
T-3 is bottom min 1 oz copper (1.4 mil)

http://rusefi.com/		
Sheet:		
File: 02_input_CJ125.kicad_pcb		
Title: CJ125 Wide 02		
Size: A	Date: 2017-01-30	Rev: R0.3
KiCad E.D.A. kicad 4.0.5		Id: 1/1